

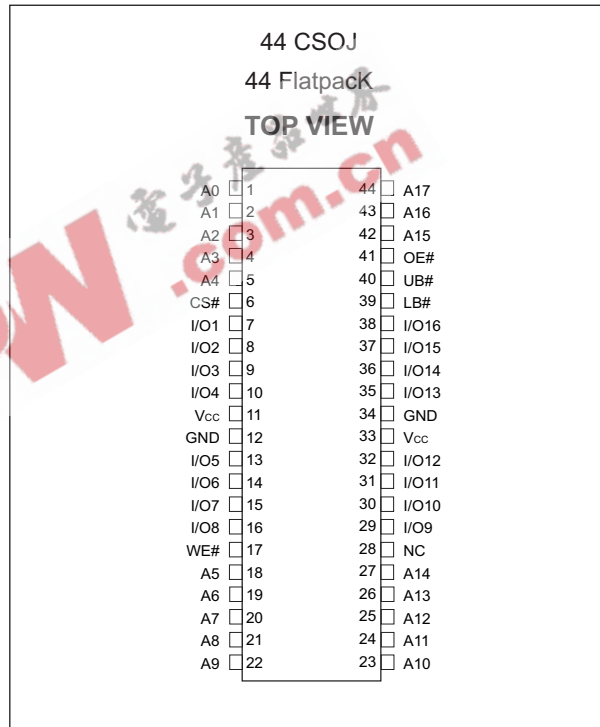


## 256Kx16 MONOLITHIC SRAM, SMD 5962-96902

### FEATURES

- Access Times 17, 20, 25, 35ns
- MIL-STD-883 Compliant Devices Available
- Packaging
  - 44 pin Ceramic SOJ (Package 102)
  - 44 lead Ceramic Flatpack (Package 225)
  - 44 lead Formed Ceramic Flatpack
- Organized as 256Kx16
- Data Byte Control:
  - Lower Byte (LB#) = I/O<sub>1-8</sub>
  - Upper Byte (UB#) = I/O<sub>9-16</sub>
- 2V Minimum Data Retention for battery back up operation (WMS256K16L-XXX Low Power Version Only)
- Commercial, Industrial and Military Temperature Range
- 5V Power Supply
- Low Power CMOS
- TTL Compatible Inputs and Outputs

### PIN CONFIGURATION FOR WMS256K16-XXX



### PIN DESCRIPTION

|                     |   |
|---------------------|---|
| A0-17               | Address Inputs                            |
| LB#                 | Lower-Byte Control (I/O <sub>1-8</sub> )  |
| UB#                 | Upper-Byte Control (I/O <sub>9-16</sub> ) |
| I/O <sub>1-16</sub> | Data Input/Output                         |
| CS#                 | Chip Select                               |
| OE#                 | Output Enable                             |
| WE#                 | Write Enable                              |
| Vcc                 | +5.0V Power                               |
| GND                 | Ground                                    |
| NC                  | No Connection                             |



**TRUTH TABLE**

| CS# | WE# | OE# | LB# | UB# | Mode           | Data I/O           |                     | Power   |
|-----|-----|-----|-----|-----|----------------|--------------------|---------------------|---------|
|     |     |     |     |     |                | I/O <sub>1-8</sub> | I/O <sub>9-16</sub> |         |
| H   | X   | X   | X   | X   | Not Select     | High Z             | High Z              | Standby |
| L   | H   | H   | X   | X   | Output Disable | High Z             | High Z              | Active  |
| L   | X   | X   | H   | H   |                |                    |                     |         |
| L   | H   | L   | L   | H   | Read           | Data Out           | High Z              | Active  |
|     |     |     | H   | L   |                | High Z             | Data Out            |         |
|     |     |     | L   | L   |                | Data Out           | Data Out            |         |
| L   | L   | X   | L   | H   | Write          | Data In            | High Z              | Active  |
|     |     |     | H   | L   |                | High Z             | Data In             |         |
|     |     |     | L   | L   |                | Data In            | Data In             |         |

**ABSOLUTE MAXIMUM RATINGS**

| Parameter                      | Symbol           | Min  | Max                  | Unit |
|--------------------------------|------------------|------|----------------------|------|
| Operating Temperature          | T <sub>A</sub>   | -55  | +125                 | °C   |
| Storage Temperature            | T <sub>STG</sub> | -65  | +150                 | °C   |
| Signal Voltage Relative to GND | VG               | -0.5 | V <sub>CC</sub> +0.5 | V    |
| Junction Temperature           | T <sub>J</sub>   |      | 150                  | °C   |
| Supply Voltage                 | V <sub>CC</sub>  | -0.5 | 7.0                  | V    |

**RECOMMENDED OPERATING CONDITIONS**

| Parameter              | Symbol          | Min  | Max                   | Unit |
|------------------------|-----------------|------|-----------------------|------|
| Supply Voltage         | V <sub>CC</sub> | 4.5  | 5.5                   | V    |
| Input High Voltage     | V <sub>IH</sub> | 2.2  | V <sub>CC</sub> + 0.3 | V    |
| Input Low Voltage      | V <sub>IL</sub> | -0.3 | +0.8                  | V    |
| Operating Temp. (Mil.) | T <sub>A</sub>  | -55  | +125                  | °C   |

**CAPACITANCE**

T<sub>A</sub> = +25°C

| Parameter          | Symbol           | Condition                         | Max | Unit |
|--------------------|------------------|-----------------------------------|-----|------|
| Input capacitance  | C <sub>IN</sub>  | V <sub>IN</sub> = 0V, f = 1.0MHz  | 20  | pF   |
| Output capacitance | C <sub>OUT</sub> | V <sub>OUT</sub> = 0V, f = 1.0MHz | 20  | pF   |

This parameter is guaranteed by design but not tested.

**DC CHARACTERISTICS**

V<sub>CC</sub> = 5.0V, GND = 0V, -55°C ≤ T<sub>A</sub> ≤ +125°C

| Parameter                | Symbol          | Conditions  | Min | Max | Units |
|--------------------------|-----------------|---|-----|-----|-------|
| Input Leakage Current    | I <sub>LI</sub> | V <sub>CC</sub> = 5.5, V <sub>IN</sub> = GND to V <sub>CC</sub>                           |     | 10  | μA    |
| Output Leakage Current   | I <sub>LO</sub> | CS# = V <sub>IH</sub> , OE# = V <sub>IH</sub> , V <sub>OUT</sub> = GND to V <sub>CC</sub> |     | 10  | μA    |
| Operating Supply Current | I <sub>CC</sub> | CS# = V <sub>IL</sub> , OE# = V <sub>IH</sub> , f = 5MHz, V <sub>CC</sub> = 5.5           |     | 275 | mA    |
| Standby Current          | I <sub>SB</sub> | CS# = V <sub>IH</sub> , OE# = V <sub>IH</sub> , f = 5MHz, V <sub>CC</sub> = 5.5           |     | 17  | mA    |
| Output Low Voltage       | V <sub>OL</sub> | I <sub>OL</sub> = 6mA, V <sub>CC</sub> = 4.5  |     | 0.4 | V     |
| Output High Voltage      | V <sub>OH</sub> | I <sub>OH</sub> = -4.0mA, V <sub>CC</sub> = 4.5   | 2.4 |     | V     |

NOTE: DC test conditions: V<sub>IH</sub> = V<sub>CC</sub> - 0.3V, V<sub>IL</sub> = 0.3V

**LOW POWER DATA RETENTION CHARACTERISTICS (WMS256K16L-XXX ONLY)**

-55°C ≤ T<sub>A</sub> ≤ +125°C

| Parameter                     | Symbol                         | Conditions                   | Min | Typ | Max | Units |
|-------------------------------|--------------------------------|------------------------------|-----|-----|-----|-------|
| Data Retention Supply Voltage | V <sub>DR</sub>                | CS# ≥ V <sub>CC</sub> - 0.2V | 2.0 |     | 5.5 | V     |
| Data Retention Current        | I <sub>CCDR</sub> <sup>1</sup> | V <sub>CC</sub> = 3V         |     | 1.0 | 8.0 | mA    |



**AC CHARACTERISTICS**

V<sub>CC</sub> = 5.0V, GND = 0V, -55°C ≤ T<sub>A</sub> ≤ +125°C

| Parameter                          | Symbol                        | -17 |     | -20 |     | -25 |     | -35 |     | Units |
|------------------------------------|-------------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-------|
|                                    |                               | Min | Max | Min | Max | Min | Max | Min | Max |       |
| Read Cycle                         |                               |     |     |     |     |     |     |     |     |       |
| Read Cycle Time                    | t <sub>RC</sub>               | 17  |     | 20  |     | 25  |     | 35  |     | ns    |
| Address Access Time                | t <sub>AA</sub>               |     | 17  |     | 20  |     | 25  |     | 35  | ns    |
| Output Hold from Address Change    | t <sub>OH</sub>               | 0   |     | 0   |     | 0   |     | 0   |     | ns    |
| Chip Select Access Time            | t <sub>ACS</sub>              |     | 17  |     | 20  |     | 25  |     | 35  | ns    |
| Output Enable to Output Valid      | t <sub>OE</sub>               |     | 10  |     | 12  |     | 15  |     | 20  | ns    |
| Chip Select to Output in Low Z     | t <sub>CLZ</sub> <sup>1</sup> | 2   |     | 5   |     | 5   |     | 5   |     | ns    |
| Output Enable to Output in Low Z   | t <sub>OLZ</sub> <sup>1</sup> | 0   |     | 0   |     | 0   |     | 0   |     | ns    |
| Chip Disable to Output in High Z   | t <sub>CHZ</sub> <sup>1</sup> |     | 9   |     | 10  |     | 12  |     | 15  | ns    |
| Output Disable to Output in High Z | t <sub>OHZ</sub> <sup>1</sup> |     | 9   |     | 10  |     | 12  |     | 15  | ns    |
| LB#, UB# Access Time               | t <sub>BA</sub>               |     | 10  |     | 12  |     | 14  |     | 17  | ns    |
| LB#, UB# Enable to Low Z Output    | t <sub>BLZ</sub> <sup>1</sup> | 0   |     | 0   |     | 0   |     | 0   |     | ns    |
| LB#, UB# Disable to High Z Output  | t <sub>BHZ</sub> <sup>1</sup> |     | 9   |     | 10  |     | 12  |     | 15  | ns    |

1. This parameter is guaranteed by design but not tested.

**AC CHARACTERISTICS**

V<sub>CC</sub> = 5.0V, GND = 0V, -55°C ≤ T<sub>A</sub> ≤ +125°C

| Parameter                        | Symbol                        | -17 |     | -20 |     | -25 |     | -35 |     | Units |
|----------------------------------|-------------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-------|
|                                  |                               | Min | Max | Min | Max | Min | Max | Min | Max |       |
| Write Cycle                      |                               |     |     |     |     |     |     |     |     |       |
| Write Cycle Time                 | t <sub>WC</sub>               | 17  |     | 20  |     | 25  |     | 35  |     | ns    |
| Chip Select to End of Write      | t <sub>CW</sub>               | 14  |     | 17  |     | 20  |     | 25  |     | ns    |
| Address Valid to End of Write    | t <sub>AW</sub>               | 14  |     | 17  |     | 20  |     | 25  |     | ns    |
| Data Valid to End of Write       | t <sub>DW</sub>               | 10  |     | 12  |     | 15  |     | 20  |     | ns    |
| Write Pulse Width                | t <sub>WP</sub>               | 14  |     | 17  |     | 20  |     | 25  |     | ns    |
| Address Setup Time               | t <sub>AS</sub>               | 0   |     | 0   |     | 0   |     | 0   |     | ns    |
| Address Hold Time                | t <sub>AH</sub>               | 2   |     | 2   |     | 2   |     | 2   |     | ns    |
| Output Active from End of Write  | t <sub>OW</sub> <sup>1</sup>  | 0   |     | 0   |     | 0   |     | 0   |     | ns    |
| Write Enable to Output in High Z | t <sub>WHZ</sub> <sup>1</sup> |     | 9   |     | 10  |     | 10  |     | 15  | ns    |
| Data Hold Time                   | t <sub>DH</sub>               | 0   |     | 0   |     | 0   |     | 0   |     | ns    |
| LB#, UB# Valid to End of Write   | t <sub>BW</sub>               | 14  |     | 17  |     | 20  |     | 25  |     | ns    |

1. This parameter is guaranteed by design but not tested.

**AC TEST CIRCUIT**



**AC TEST CONDITIONS**

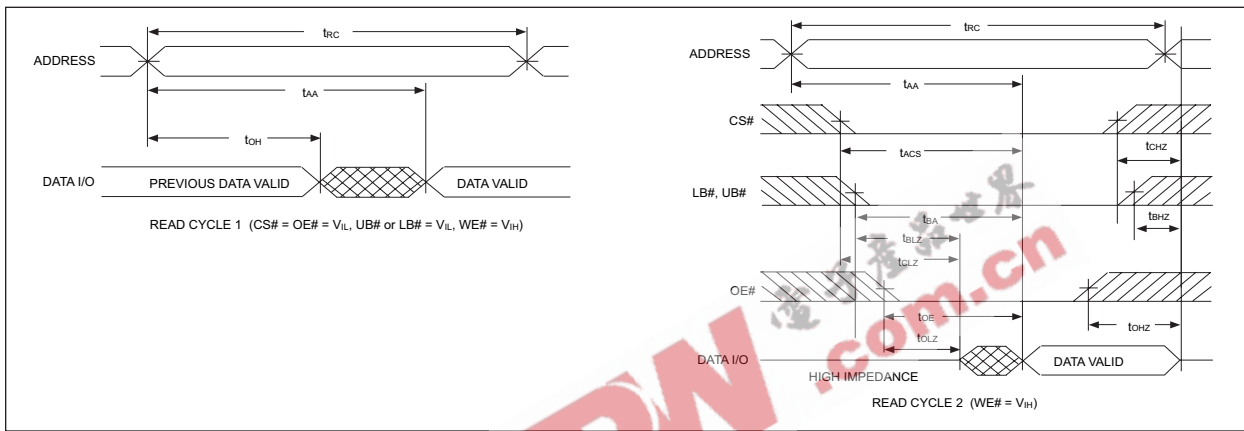
| Parameter                        | Typ  | Unit |
|----------------------------------|--|------|
| Input Pulse Levels               | V <sub>IL</sub> = 0, V <sub>IH</sub> = 3.0 | V    |
| Input Rise and Fall              | 5  | ns   |
| Input and Output Reference Level | 1.5  | V    |
| Output Timing Reference Level    | 1.5  | V    |

Notes:

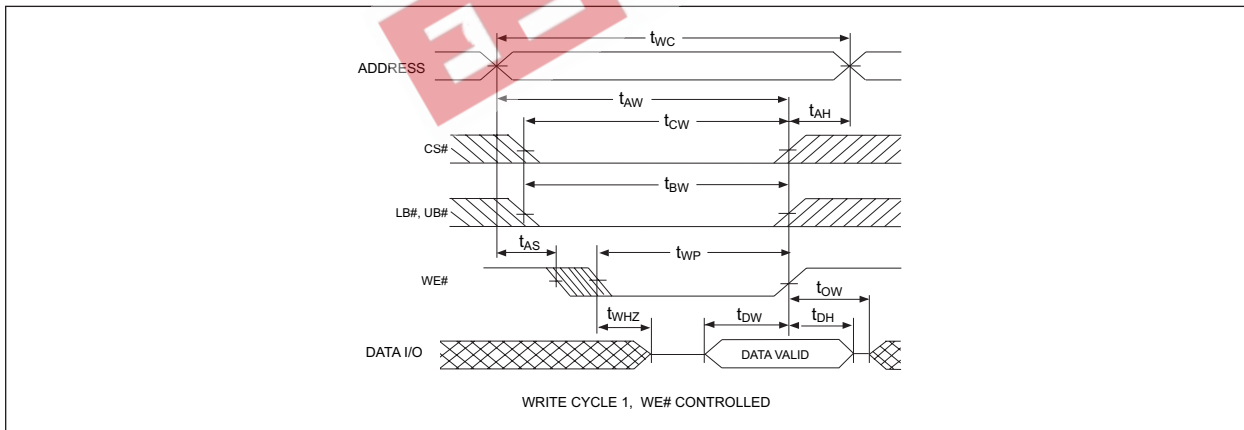
- V<sub>Z</sub> is programmable from -2V to +7V.
- I<sub>OL</sub> & I<sub>OH</sub> programmable from 0 to 16mA.
- Tester Impedance Z<sub>0</sub> = 75 Ω.
- V<sub>Z</sub> is typically the midpoint of V<sub>OH</sub> and V<sub>OL</sub>.
- I<sub>OL</sub> & I<sub>OH</sub> are adjusted to simulate a typical resistive load circuit.
- ATE tester includes jig capacitance.



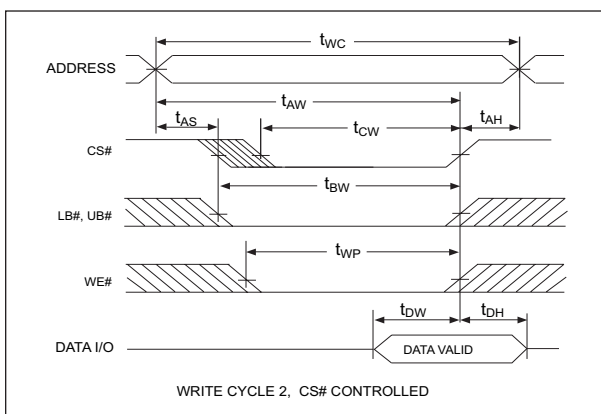
TIMING WAVEFORM - READ CYCLE



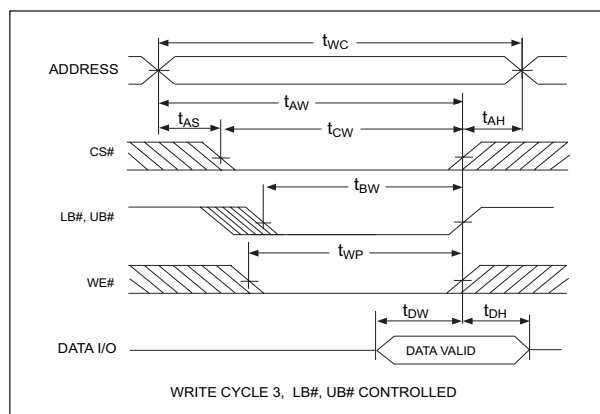
WRITE CYCLE - WE# CONTROLLED



WRITE CYCLE - CS# CONTROLLED



WRITE CYCLE - LB#, UB# CONTROLLED





PACKAGE 102: 44 LEAD, CERAMIC SOJ



ALL LINEAR DIMENSIONS ARE MILLIMETERS AND PARENTHETICALLY IN INCHES

PACKAGE 225: 44 LEAD, CERAMIC FLAT PACK



ALL LINEAR DIMENSIONS ARE MILLIMETERS AND PARENTHETICALLY IN INCHES



**PACKAGE 211: 44 LEAD FORMED, CERAMIC FLAT PACK**



ALL LINEAR DIMENSIONS ARE MILLIMETERS AND PARENTHETICALLY IN INCHES

**ORDERING INFORMATION**

**W M S 256K16 X - XXX X X X**

**LEAD FINISH:**

- Blank = Gold plated leads
- A = Solder dip leads

**DEVICE GRADE:**

- M = Military Screened -55°C to +125°C
- I = Industrial -40°C to +85°C
- C = Commercial 0°C to +70°C

**PACKAGE:**

- DL = 44 Lead Ceramic SOJ (Package 102)
- FL = 44 Lead Ceramic Flatpack (Package 225)
- FG = 44 Lead Formed Ceramic Flatpack

**ACCESS TIME (ns)**

**IMPROVEMENT MARK:**

- Blank = Standard Power
- L = Low Power Data Retention

**ORGANIZATION, 256K x 16**

**SRAM**

**MONOLITHIC**

**WHITE ELECTRONIC DESIGNS CORP.**



| DEVICE TYPE               | SPEED | PACKAGE                      | SMD NO.          |
|---------------------------|-------|------------------------------|------------------|
| 256K x 16 SRAM Monolithic | 35ns  | 44 lead SOJ (DL)             | 5962-96902 01HMX |
| 256K x 16 SRAM Monolithic | 25ns  | 44 lead SOJ (DL)             | 5962-96902 02HMX |
| 256K x 16 SRAM Monolithic | 20ns  | 44 lead SOJ (DL)             | 5962-96902 03HMX |
| 256K x 16 SRAM Monolithic | 17ns  | 44 lead SOJ (DL)             | 5962-96902 04HMX |
| 256K x 16 SRAM Monolithic | 35ns  | 44 lead Flatpack (FL)        | 5962-96902 01HNX |
| 256K x 16 SRAM Monolithic | 25ns  | 44 lead Flatpack (FL)        | 5962-96902 02HNX |
| 256K x 16 SRAM Monolithic | 20ns  | 44 lead Flatpack (FL)        | 5962-96902 03HNX |
| 256K x 16 SRAM Monolithic | 17ns  | 44 lead Flatpack (FL)        | 5962-96902 04HNX |
| 256K x 16 SRAM Monolithic | 35ns  | 44 lead Formed Flatpack (FG) | 5962-96902 01HTX |
| 256K x 16 SRAM Monolithic | 25ns  | 44 lead Formed Flatpack (FG) | 5962-96902 02HTX |
| 256K x 16 SRAM Monolithic | 20ns  | 44 lead Formed Flatpack (FG) | 5962-96902 03HTX |
| 256K x 16 SRAM Monolithic | 17ns  | 44 lead Formed Flatpack (FG) | 5962-96902 04HTX |